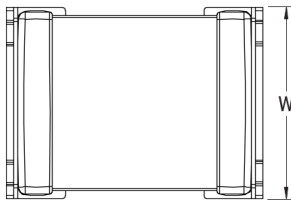


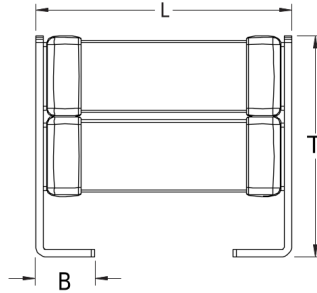
TOP VIEW

Single or Double Chip Stack



SIDE VIEW

Double Chip Stack



General Information

| | |
|------------------|-----------------------------------------------------|
| Series | KPS SMD Comm X7R |
| Style | Stacked Chip |
| Description | SMD, MLCC, Stacked, Double Chip, Temperature Stable |
| Features | Temperature Stable |
| RoHS | Yes |
| Termination | Tin |
| AEC-Q200 | No |
| Component Weight | 310 mg |
| Chip Size | 1812-2 |
| Shelf Life | 78 Weeks |
| MSL | 1 |

Specifications

| | |
|--------------------------------------------------------------------|-------------------------------------------------|
| Capacitance | 0.47 uF |
| Measurement Condition | 1 kHz 1.0Vrms |
| Capacitance Tolerance | 20% |
| Voltage DC | 250 VDC |
| Dielectric Withstanding Voltage | 625 VDC |
| Temperature Range | -55/+125°C |
| Temperature Coefficient | X7R |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 15%, 1kHz 1.0Vrms |
| Dissipation Factor | 2.5% 1kHz 1.0Vrms |
| Aging Rate | 3% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 2.1277 GOhms |

Click [here](#) for the 3D model.

Dimensions

| | |
|---|----------------|
| L | 5mm +/-0.5mm |
| W | 3.5mm +/-0.5mm |
| T | 5mm +/-0.5mm |
| B | 1.1mm +/-0.3mm |

Packaging Specifications

| | |
|--------------------|--------------------------|
| Packaging | T&R, 330mm, Plastic Tape |
| Packaging Quantity | 1700 |